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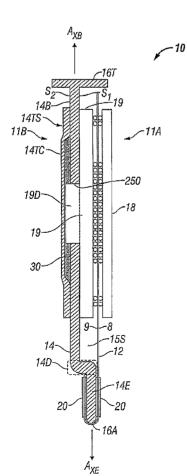
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(54) Title: OPTIMIZED MOUNTING AREA CIRCUIT MODULE SYSTEM AND METHOD



(57) Abstract: A flexible circuitry is populated with integrated circuitry (ICs) disposed along one or both of its major sides. Contacts are distributed along the flexible circuitry to provide connection between the module and an application environment. A rigid substrate is configured to provide space on one side where the populated flex is disposed while in some embodiments, heat management or cooling structures are arranged on one side of the module to mitigate thermal accumulation in the module.



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Minimum documentation searched (classification system followed by classification symbols) U.S.: 361/749.703.711.719.735.789.690			
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Electronic data base consulted during the international search (name of data base and, where practicable, search terms used) Google/ www/ CSP, AMB, processor, expansion cards or modules, thermal conductive substrate			
C. DOC	UMENTS CONSIDERED TO BE RELEVANT		
Category *	Citation of document, with indication, where a	ppropriate, of the relevant passages	Relevant to claim No.
X	US 6,012,048 (smith) 1 Feb 2000, Column 2 lines 27	7-63, column 4 lines 13-14	1-4, 10, 14, 15, 18, 20, 21
Y	US 5,138.523 (Benck et al) 11 August 1992 column 3 lines 38-40		5,6, 30
Y	US 5,138,523 (Benck et al) 11August 1992, column 4 line 66		7,8,19,22,26
Y	US 5,138,523 (Benck et al) 11August 1992, column 4 lines 57-60		9,27
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